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AMENDMENTS TO THE SPECIFICATION

Please amend the paragraph at page 7, lines 8-19, of the specification, as follows:

Referring to FIG. 2B, an enlargement of a sectional view of the metallic linking piece and cable along the section line 2B-2B in FIG 2A is illustrated. FIG. 2B differs from FIG. 1A in that the cable 216 in FIG. 2B is further equipped with a metallic layer 210 and 89 micro-strip grounding pieces 220. The 89 micro-strip grounding pieces 220 are interlaced with the 90 signal lines 126, with the metallic layer 210 216 being located beside the signal line 126 and the micro-strip grounding piece 220 being electrically connected with the metallic layer 210. The micro-strip grounding piece 220 of the invention separates every two adjacent signal lines 126, giving the micro-strip grounding piece 220 absolute shielding effect, such that the EMI effect generated from within the 90 signal lines 126 will not interfere with the signal transmission of the telephone. Of which, the metallic layer 210 can be a copper foil layer, while the micro-strip grounding piece 220 can be made of copper.

